

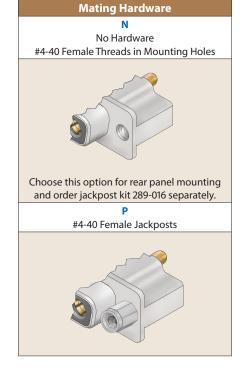
280-056P right angle PC tail pin connectors with low profile mounting flange



The HiPer-D° is a high performance version of the M24308-type D-Subminiature connector. HiPer-D° connectors feature improved EMI performance and environmental sealing. Factory-installed PC tail contacts, integral board standoffs and threaded holes for attaching to circuit board. Optional ground springs for improved resistance to electromagnetic interference. Gold-plated copper alloy contacts, one-piece machined aluminum shell, glass-reinforced thermoset epoxy insulator, epoxy potting compound, fluorosilicone face seal. 1000 VAC, 7.5 Amps (#20), up to 40 Amps with size #8 power contacts.

How To Order											
Sample Part Number		280-056P	3-5P5	Z 2	G	Р	A				
Basic Part Number	280-056P										
Shell Size- Contact Arrangement	See Shell Size - Contact Arrangements Table										
Shell Finish	ME = Electroless Nickel MT = Nickel-PTFE JF = Cadmium with Yellow Chromate Z2 = Gold Z1 = Passivated Stainless Steel										
Ground Spring	G = Supplied with EMI Ground Spring N = No Ground Spring										
Mating Hardware	N = No Hardware P = #4-40 Female Jackpost										
PC Tail Length	A = .125 (3.18) Tail Length B = .250 (6.35) Tail Length										

Contact Arrangements								
Shell Size-	Contact Size and Qty							
Contact Arr.	#20	#8						
1-2P2		2						
1-5P1	4	1						
2-3P3		3						
2-7P2	5	2						
2-11P1	10	1						
3-5P5		5						
3-9P4	5	4						
3-13P3	10	3						
3-17P2	15	2						
3-21P1	20	1						
4-8P8		8						
4-13P6	7	6						
4-17P5	12	5						
4-21PA4	17	4						
4-25P3	22	3						
4-27P2	25	2						
5-24P7	17	7						
5-36P4	32	4						
5-43P2	41	2						
5-47P1	46	1						



Specifications								
Current Rating	#20 7.5 AMPS, #8 40 AMPS							
Test Voltage	1000 VAC RMS							
Insulation Resistance	5000 megohms minimum							
Operating Temperature	-65° C. to +200° C.							
Ingress Protection	IP 67							
Shock	300 g.							
Vibration, Random	43.92 g.							

Materials and Finishes							
Shell	Aluminum alloy						
Contacts	Copper alloy, 50 microinches gold						
Insulator	Thermoset epoxy						
EMI Spring	Copper alloy, nickel plated						
Face Seal	Fluorosilicone rubber						
Hardware	300 series stainless steel						
Shroud, Contact	Aluminum alloy						

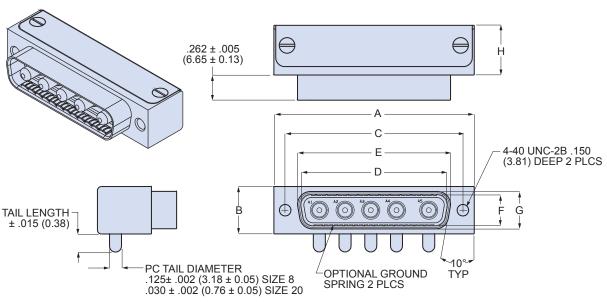
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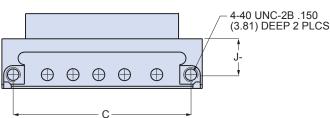
HiPer-D® Combo Connectors

Glenair.

280-056P right angle PC tail pin connectors with low profile mounting flange

280-056P DIMENSIONS





Dimensions																		
Shell Size	Α		В		C Basic		D		E		F		G		Н		J	
	in ± .015	mm ± 0.38	in ± .015	mm ± 0.38	in.	mm	in ± .005	mm ± 0.13	in ±.005	mm ± 0.13	in ±.005	mm ± 0.13	in ± .005	mm ± 0.13	in	mm	in ±.005	mm ± 0.13
1	1.213	30.81	.494	12.55	.984	24.99	.666	16.92	.726	18.44	.329	8.36	.389	9.88	.518	13.16	.374	9.50
2	1.541	39.14	.494	12.55	1.312	33.32	.994	25.25	1.054	26.77	.329	8.36	.389	9.88	.518	13.16	.374	9.50
3	2.088	53.04	.494	12.55	1.852	47.04	1.534	38.96	1.594	40.49	.329	8.36	.389	9.88	.518	13.16	.374	9.50
4	2.729	69.32	.494	12.55	2.500	63.50	2.182	55.42	2.242	56.95	.329	8.36	.389	9.88	.518	13.16	.374	9.50
5	2.635	66.93	.605	15.37	2.406	61.11	2.079	52.81	2.139	54.33	.441	11.20	.501	12.73	.630	16.00	.430	10.92

NOTES

- 1. Contacts are factory-installed, non-removable and are potted with epoxy.
- 2. HiPer-D° connectors are available with a wide variety of materials and finishes. See **About Series 28 HiPer-D° Shell Plating Options** for additional choices .
- 3. For panel cutout dimensions, refer to Panel Cutouts and Printed Circuit Board Footprints.
- 4. For printed circuit board mounting dimensions, refer to Panel Cutouts and Printed Circuit Board Footprints.
- 5. Combo HiPer-D° connectors meet the applicable requirements of MIL-DTL-24308 and are intermateable with standard M24308-type D-Subminiature combo connectors with corresponding contact arrangements and type.
- 6. Additional electrical, mechanical and environmental specifications are listed in HiPer-D° Product Specification.